

07-25-2002



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Tab settings

To the Honorable Commissioner of Patents and

to record the attached original documents or copy thereof

1. Name of conveying party(ies):

Chi-Chuan WU
Chien-Ping HUANG
Han-Ping PU

7-16-02

Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):

Name: Siliconware Precision Industries Co., Inc.

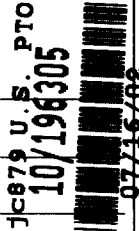
Address: No. 123, Sec. 3, Da Fong Rd.

Tantzu, Taichung, Taiwan, R.O.C.

City: _____ State/Prov.: _____

Country: _____ ZIP: _____

Additional name(s) & address(es) Yes No



3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: July 4, 2002

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: July 16, 2002

Patent Application No. _____ Filing date _____

10,196,305

B. Patent No.(s)

07/22/2002 EFLORES 00000043 10196305

02 FC:581

40.00 DP

Additional numbers

Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Peter F. Corless

Registration No. 33,860

Address: EDWARDS & ANGELL, LLP

P.O. Box 9169

City: Boston State/Prov.: MA

Country: USA ZIP: 02209

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

Enclosed - Any excess or insufficiency should be credited or debited to deposit account

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8. Deposit account number:

04-1105

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Christine C. O'Day (Reg. No. 38,256)

July 16, 2002

Name of Person Signing

Signature

Date

2

Total number of pages including cover sheet, attachments, and

ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar (\$1.00) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned

Inventor(s) Full Name(s)

- 1) Chi-Chuan WU
2) Chien-Ping HUANG
3) Han-Ping PU

Assignee Name and Address

hereby sell, assign and transfer to SILICONWARE PRECISION INDUSTRIES CO., LTD. No. 123, Sec. 3, Da Fong Rd., Tantz, Taichung, Taiwan, R.O.C.

Title of Invention

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled FLIP-CHIP SEMICONDUCTOR PACKAGE WITH LEAD FRAME AS CHIP CARRIER AND FABRICATION METHOD THEREOF

Complete either a) or b)

which application was a) executed by the undersigned on the ... day of ..., 19 ... b) filed on the ... day of ..., 19 ...

Serial No ... including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Date

Signed at ... TAICHUNG ... this ... 4th day of ... JULY ... , 2002.

Inventor(s) Full Signature(s)

INVENTOR(S): Chi-Chuan Wu July 4 '2001 Chien-Ping Huang July 4, 2001 Han-Ping PU July 4, 2001

Witnesses' Full Signatures

WITNESSES: